

54ACTQ/74ACTQ16373 16-Bit Transparent Latch with TRI-STATE® Outputs

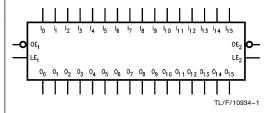
General Description

The 'ACTQ16373 contains sixteen non-inverting latches with TRI-STATE outputs and is intended for bus oriented applications. The device is byte controlled. The flip-flops appear transparent to the data when the Latch Enable (LE) is HIGH. When LE is low, the data that meets the setup time is latched. Data appears on the bus when the Output Enable (OE) is LOW. When OE is HIGH, the outputs are in high Z state. The 'ACTQ16373 utilizes NSC Quiet Series technology to guarantee quiet output switching and improved dynamic threshold performance. FACT Quiet SeriesTM features GTOTM output control for superior performance.

Features

- Utilizes NSC FACT Quiet Series technology
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Guaranteed pin-to-pin output skew
- Separate control logic for each byte
- 16-bit version of the 'ACTQ373
- Outputs source/sink 24 mA
- Additional specs for Multiple Output Switching
- Output Loading specs for both 50 pF and 250 pF loads

Logic Symbol

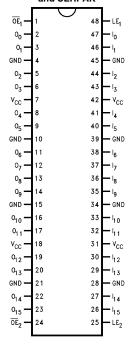


Pin Description

Pin Names	Description
ŌĒn	Output Enable Input (Active Low)
LE _n	Latch Enable Input
l ₀ -l ₁₅	Inputs
O ₀ -O ₁₅	Outputs

Connection Diagram

Pin Assignment for SSOP and CERPAK



TL/F/10934-2

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Functional Description

The 'ACTQ16373 contains sixteen D-type latches with TRI-STATE standard outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 16-bit operation. The following description applies to each byte. When the Latch Enable (LEn) input is HIGH, data on the D_n enters the latches. In this condition the latches are transparent, i.e., a latch output will change states each time its D input changes. When LE_n is LOW, the latches store information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE_n. The TRI-STATE standard outputs are controlled by the Output Enable (\overline{OE}_n) input. When \overline{OE}_n is LOW, the standard outputs are in the 2-state mode. When \overline{OE}_n is HIGH, the standard outputs are in the 2-state mode. dard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Truth Tables

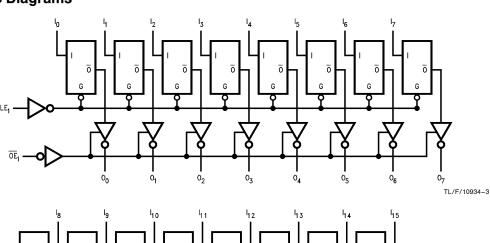
	Inputs	Outputs	
LE ₁	ŌE ₁	I ₀ -I ₇	00-07
Х	Н	X	Z
Н	L	L	L
Н	L	Н	Н
L	L	X	(Previous)

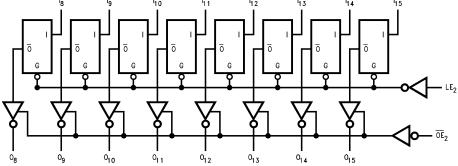
	Inputs					
LE ₂	\overline{OE}_2	I ₈ -I ₁₅	O ₈ -O ₁₅			
Х	Н	X	Z			
Н	L	L	L			
Н	L	Н	Н			
L	L	X	(Previous)			

- H = High Voltage Level
- L = Low Voltage Level X = Immaterial
- Z = High Impedance

Previous = previous output prior to HIGH to LOW transition of LE

Logic Diagrams





TL/F/10934-4

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC}) -0.5V to +7.0V

DC Input Diode Current (I_{IK}) $V_1 = -0.5V$

-20 mA $V_I = V_{CC} + 0.5V$ \pm 20 mA

DC Output Diode Current (I_{OK})

 $V_{\mbox{O}} = -0.5 V$ $-20\ mA$ $V_O = V_{CC} + 0.5V$ +20 mA

DC Output Voltage (VO) -0.5V to $V_{\hbox{\footnotesize CC}}\,+\,0.5V$ DC Output Source/Sink Current (I_O) $+50 \, \text{mA}$

DC V_{CC} or Ground Current +50 mAper Output Pin

Junction Temperature

CDIP

+175°C PDIP/SOIC +140°C Storage Temperature -65°C to +150°C

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of FACT™ circuits outside databook specifications.

Recommended Operating Conditions

Supply Voltage (V_{CC}) 'ACTQ

4.5V to 5.5V Input Voltage (V_I) 0V to V_{CC} 0V to V_{CC} Output Voltage (V_O)

Operating Temperature (T_A)

74ACTQ -40°C to $+85^{\circ}\text{C}$ 54ACTQ -55°C to $+125^{\circ}\text{C}$

Minimum Input Edge Rate (dV/dt)

125 mV/ns 'ACTQ Devices

V_{IN} from 0.8V to 2.0V

V_{CC} @ 4.5V, 5.5V

DC Electrical Characteristics for 'ACTQ Family Devices

	Symbol Parameter		74A	СТQ	54ACTQ	74ACTQ		
Symbol			T _A = +25°C		T _A = -55°C to +125°C	T _A = -40°C to +85°C	Units	Conditions
			Тур		Guaranteed L	imits		
V _{IH}	Minimum High Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	2.0 2.0	٧	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
V _{IL}	Maximum Low Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	0.8 0.8	٧	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$
V _{OH}	Minimum High Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	4.4 5.4	٧	$I_{OUT} = -50 \mu A$
		4.5 5.5		3.86 4.86	3.70 4.70	3.76 4.76	V	$V_{\text{IN}}^* = V_{\text{IL}} \text{ or } V_{\text{IH}}$ -24 mA -24 mA
V _{OL}	Maximum Low Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	0.1 0.1	٧	$I_{OUT} = 50 \mu A$
		4.5 5.5		0.36 0.36	0.50 0.50	0.44 0.44	V	$V_{IN}^* = V_{IL} \text{ or } V_{IH}$ I_{OL} 24 mA 24 mA
I _{OZ}	Maximum TRI-STATE Leakage Current	5.5		±0.5	± 10.0	±5.0	μΑ	$V_I = V_{IL}, V_{IH}$ $V_O = V_{CC}, GND$
I _{IN}	Maximum Input Leakage Current	5.5		±0.1	±1.0	±1.0	μΑ	$V_I = V_{CC}$, GND
ICCT	Maximum I _{CC} /Input	5.5	0.6		1.6	1.5	mA	$V_I = V_{CC} - 2.1V$
Icc	Max Quiescent Supply Current	5.5		8.0	160.0	80.0	μΑ	$V_{IN} = V_{CC}$ or GND (Note 5)
I _{OLD}	†Minimum Dynamic	5.5			50	75	mA	$V_{OLD} = 1.65V Max$
I _{OHD}	Output Current	0.0			50	-75	mA	V _{OHD} = 3.85V Min

^{*}All outputs loaded; thesholds associated with output unders test.

[†]Maximum test duration 2.0 ms; one output loaded at a time.

DC Electrical Characteristics for 'ACTQ Family Devices (Continued)

			74A	СТQ	54ACTQ	74ACTQ		
Symbol	Parameter	V _{CC} (V)	T _A =	+ 25°C	T _A = -55°C to +125°C	$ extsf{T}_{ extsf{A}} = -40^{\circ} extsf{C} extsf{ to } +85^{\circ} extsf{C}$	Units	Conditions
			TYP		Guaranteed Lim	iits		
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	5.0	0.5	0.8			٧	Figures 2-12, 13 (Notes 2, 3)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	5.0	-0.5	-1.0			٧	Figures 2-12, 13 (Notes 2, 3)
V _{OHP}	Maximum Overshoot	5.0	V _{OH} + 1.0	V _{OH} + 1.5			V	Figures 2-12, 13 (Notes 1, 3)
V _{OHV}	Minimum V _{CC} Droop	5.0	V _{OH} - 1.0	V _{OH} - 1.8			>	Figures 2-12, 13 (Notes 1, 3)
V _{IHD}	Minimum High Dynamic Input Voltage Level	5.0	1.7	2.0			V	(Notes 1,4)
V _{ILD}	Maximum Low Dynamic Input Voltage Level	5.0	1.2	0.8			V	(Notes 1,4)

Note 1: Worst case package

Note 2: Maximum number of outputs that can switch simultaneously is n. (n-1) outputs are switched LOW and one output held LOW.

Note 3: Maximum number of outputs that can switch simultaneously is n. (n - 1) outputs are switched HIGH and one output held HIGH.

Note 4: Max number of data inputs (n) switching, (n - 1) input switching 0V to 3V ('ACTQ). Input under test switching 3V to threshold (V_{ILD})

Note 5: I_{CC} for 54ACTQ @ 25°C is indentical to 74ACTQ @ 25°C.

AC Electrical Characteristics:

			74ACTQ		54A	сто	74A	_		
Symbol Parameter		V _{CC} * (V)	^	= +2 = 50		$T_A = -55^{\circ}$ C to $+ 125^{\circ}$ C $C_L = 50$ pF		$T_A = -40^{\circ}\text{C to } + 85^{\circ}\text{C}$ $C_L = 50 \text{ pF}$		Units
			Min	Тур	Max	Min	Max	Min	Max	
t _{PLH}	Propagation Delay D _n to O _n	5.0	3.1 2.6	5.3 4.6	7.9 7.3	3.0 3.0	10.5 10.0	3.1 2.6	8.4 7.8	ns
t _{PLH}	Propagation Delay LE to O _n	5.0	3.1 2.8	5.4 4.9	7.9 7.3	3.0 3.0	11.0 10.0	3.2 2.8	8.4 7.8	ns
t _{PZH}	Output Enable Delay	5.0	2.5 2.7	4.7 4.8	7.4 7.5	2.5 2.5	10.0 11.0	2.5 2.7	7.9 8.0	ns
t _{PHZ}	Output Disable Delay	5.0	2.1 2.0	5.1 4.5	7.9 7.4	2.0 2.0	9.0 9.0	2.1 2.0	8.2 7.9	ns

^{*}Voltage Range 5.0 is 5.0V $\,\pm\,$ 0.5V.

Extended AC Electrical Characteristics

			74ACTQ			СТQ	74A	54A			
Symbol	Parameter	$T_{A}=-40^{\circ}\text{C to}+85^{\circ}\text{C}$ $V_{CC}=\text{Com}$ $C_{L}=50\text{ pF}$ 16 Outputs Switching (Note 2)		T _A = Mil V _{CC} = Mil C _L = 50 pF 16 Outputs Switching (Note 2)		$T_{A}=-40^{\circ} ext{C to} +85^{\circ} ext{C} \ ext{V}_{CC}= ext{Com} \ ext{C}_{L}=250 ext{ pF} \ ext{(Note 3)}$		T _A = Mil V _{CC} = Mil C _L = 250 pF (Note 3)		Units	
		Min	Тур	Max	Min	Max	Min	Max	Min	Max	
t _{PLH}	Propagation Delay Data to Output	4.7 4.6		12.7 10.6	4.7 4.6	13.4 11.3	6.6 6.4	15.7 14.5	6.6 6.4	16.5 15.3	ns
t _{PLH} t _{PHL}	Propagation Delay Latch Enable to Output	4.6 4.1		13.3 10.4	4.6 4.1	14.1 11.0	6.3 5.8	15.3 13.6	6.3 5.8	16.3 14.4	ns
t _{PZH}	Output Enable Time	3.5 3.6		10.4 10.9	3.5 3.6	11.0 11.6	(No	te 4)	(No	te 4)	ns
t _{PHZ}	Output Disable Time	3.4 3.1		8.5 8.1	3.4 3.1	9.0 8.6	(Note 5)		(Note 5)		ns
t _{OSHL} (Note 1)	Pin to Pin Skew HL Data to Output			1.3							ns
t _{OSLH} (Note 1)	Pin to Pin Skew LH Data to Output			2.1							ns
t _{OST} (Note 1)	Pin to Pin Skew LH/HL Data to Output			4.0							ns

Note 1: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH to LOW (toSHL), LOW to HIGH (toSLH), or any combination switching LOW to HIGH and/or HIGH to LOW (toST).

Note 2: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all low-to-high, high-to-low, etc.).

Note 3: This specification is guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.

Note 4: TRI-STATE delays are load dominated and have been excluded from the datasheet.

Note 5: The Output Disable Time is dominated by the RC Network (500 Ω , 250 pF) on the output and has been excluded from the datasheet.

AC Operating Requirements:

Symbol	Symbol Parameter		74ACTQ + 25°C 50 pF		54ACTQ -55°C to +125°C 50 pF	74ACTQ -40°C to +85°C 50 pF	Units		
			Тур		Guaranteed Minimum				
ts	Setup Time, HIGH or LOW, Input to Clock	5.0		3.0	3.0	3.0	ns		
t _h	Hold time, High or LOW, Input to Clock	5.0		1.5	1.5	1.5	ns		
t _w	CS Pulse Width, HIGH or LOW	5.0		4.0	4.0	4.0	ns		

^{*}Voltage Range 5.0 is 5.0V $\pm~0.5V$

Capacitance

Symbol	Paramete	er	Тур	Units	Conditions
C _{IN}	Input Capacitance		4.5	pF	$V_{CC} = 5.0V$
C _{PD}	Power Dissipation	74ACTQ	30	pF	$V_{CC} = 5.0V$
	Capacitance	54ACTQ	95	pF	$V_{CC} = 5.0V$

FACT Noise Characteristics

The setup of a noise characteristics measurement is critical to the accuracy and repeatability of the tests. The following is a brief description of the setup used to measure the noise characteristics of FACT.

Equipment:

Hewlett Packard Model 8180A Word Generator PC-163A Test Fixture Tektronics Model 7854 Oscilloscope

Procedure:

- 1. Verify Test Fixture Loading: Standard Load 50 pF, 500Ω .
- 2. Deskew the word generator so that no two channels have greater than 150 ps skew between them. This requires that the oscilloscope be deskewed first. Swap out the channels that have more than 150 ps of skew until all channels being used are within 150 ps. It is important to deskew the word generator channels before testing. This will ensure that the outputs switch simultaneously.
- Terminate all inputs and outputs to ensure proper loading of the outputs and that the input levels are at the correct voltage.
- 4. Set V_{CC} to 5.0V.
- Set the word generator to toggle all but one output at a frequency of 1 MHz. Greater frequencies will increase DUT heating and affect the results of the measurement.

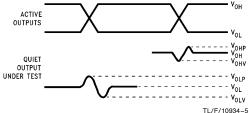


FIGURE 1. Quiet Output Noise Voltage Waveforms

Note A: V_{OHV} and V_{OLP} are measured with respect to ground reference. **Note B:** Input pulses have the following characteristics: f=1 MHz, $t_r=3$ ns, $t_f=3$ ns, skew < 150 ps.

 Set the word generator input levels at 0V LOW and 3V HIGH for ACT devices and 0V LOW and 5V HIGH for AC devices. Verify levels with a digital volt meter.

VOLP/VOLV and VOHP/VOHV:

- Determine the quiet output pin that demonstrates the greatest noise levels. The worst case pin will usually be the furthest from the ground pin. Monitor the output voltages using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- Measure V_{OLP} and V_{OLV} on the quiet output during the HL transition. Measure V_{OHP} and V_{OHV} on the quiet output during the LH transition.
- Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.

VILD and VIHD:

- Monitor one of the switching outputs using a 50Ω coaxial cable plugged into a standard SMB type connector on the test fixture. Do not use an active FET probe.
- First increase the input LOW voltage level, V_{IL}, until the output begins to oscillate. Oscillation is defined as noise on the output LOW level that exceeds V_{IL} limits, or on output HIGH levels that exceed V_{IH} limits. The input LOW voltage level at which oscillation occurs is defined as V_{II D}.
- Next increase the input HIGH voltage level on the word generator, V_{IH} until the output begins to oscillate. Oscillation is defined as noise on the output LOW level that exceeds V_{IL} limits, or on output HIGH levels that exceed V_{IH} limits. The input HIGH voltage level at which oscillation occurs is defined as V_{IHD}.
- Verify that the GND reference recorded on the oscilloscope has not drifted to ensure the accuracy and repeatability of the measurements.

TL/F/10934-6

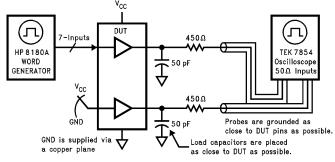
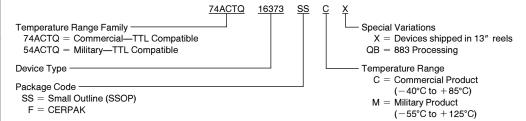


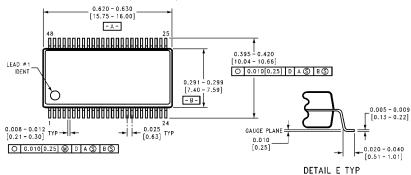
FIGURE 2. Simultaneous Switching Test Circuit

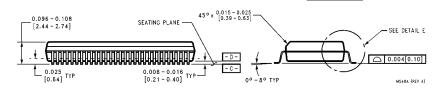
Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



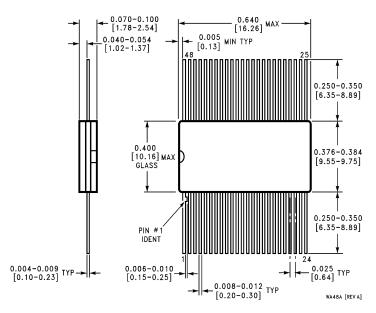
Physical Dimensions inches (millimeters)





48-Lead SSOP (0.300" Wide) (SS) NS Package Number MS48A

Physical Dimensions inches (millimeters) (Continued)



48-Lead CERPAK (F)
NS Package Number WA48A

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